

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7292025

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Yi Zhang	04/18/2022
CHAO QIAN	04/18/2022
JIARUI XU	04/18/2022
RUNXIN BEI	04/18/2022
SIWEI LIU	04/18/2022
ZHENGUO CHI	04/18/2022
RECEIVING PARTY DATA	
Name:	SUN YAT-SEN UNIVERSITY
Street Address:	NO. 135 XINGANG WEST ROAD, ZHUHAI DISTRICT
City:	GUANGZHOU
State/Country:	China
Postal Code:	
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16486802
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	91024-330
NAME OF SUBMITTER:	JUSTIN KING
SIGNATURE:	/Justin King/
DATE SIGNED:	04/21/2022
Total Attachments: 2	

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source=a#page2.tif

ASSIGNMENT

WHEREAS, ASSIGNOR,

<u>1. ZHANG, YI</u>	, residing at	<u>NO. 135 XINGANG WEST ROAD, ZHUHAI DISTRICT, GUANGZHOU</u>
<u>2. QIAN, CHAO</u>	, residing at	<u>NO. 135 XINGANG WEST ROAD, ZHUHAI DISTRICT, GUANGZHOU</u>
<u>3. XU, JIARUI</u>	, residing at	<u>NO. 135 XINGANG WEST ROAD, ZHUHAI DISTRICT, GUANGZHOU</u>
<u>4. BEI, RUNXIN</u>	, residing at	<u>NO. 135 XINGANG WEST ROAD, ZHUHAI DISTRICT, GUANGZHOU</u>
<u>5. LIU, SIWEI</u>	, residing at	<u>NO. 135 XINGANG WEST ROAD, ZHUHAI DISTRICT, GUANGZHOU</u>
<u>6. CHI, ZHENGUO</u>	, residing at	<u>NO. 135 XINGANG WEST ROAD, ZHUHAI DISTRICT, GUANGZHOU</u>

(collectively referred to as ASSIGNOR),

owns all right, title and interest in the invention as disclosed and/or claimed in the U.S. patent application, entitled Polymer with low dielectric constant and molecular structure design method capable of reducing dielectric constant of polymer, which

[x] is concurrently filed herewith; or

[] was previously filed on _____ with Application No. _____;

AND, ASSIGNEE,

<u>1. SUN YAT-SEN UNIVERSITY</u>	, having offices at	<u>NO. 135 XINGANG WEST ROAD, ZHUHAI DISTRICT, GUANGZHOU</u>
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(collectively referred to as ASSIGNEE),

desires to own ASSIGNOR's entire right, title, and interest in and to the invention and in and to the above-described U.S. patent application.


NOW THEREFORE, be it known for one U.S. dollar (US\$1) and other good and valuable consideration, receipt of which is hereby acknowledged, ASSIGNOR hereby assigns, transfers and sets over to ASSIGNEE, its lawful successors and assigns, ASSIGNOR's entire right, title, and interest in and to the invention and the U.S. patent application as described above, and other patent application, including but not limited to any continuing application, directed or to be directed to the invention, and all Letters Patent of the United States that may be granted therein, and all reissues, reexaminations, and extensions thereof; and all rights to claim priority on the basis of such application; and all applications for Letters Patent that may be filed for the invention in any other country and all Letters Patent that may be granted on the invention in any other country, and all extensions, renewals, reissues thereof; and ASSIGNOR hereby authorizes and requests the Commissioner for Patents of the United States and any official of any other country whose duty is to issue patents on patent applications, to issue all Letters Patent for this

country whose duty is to issue patents on patent applications, to issue all Letters Patent for this invention to ASSIGNEE, its successors and assigns, in accordance with the terms of this Assignment;

AND, ASSIGNOR HEREBY further covenants that ASSINOR has the full right to convey the interest assigned by this Assignment, ASSIGNOR will take all action and execute all documents necessary to perfect the interest assigned hereby, and ASSIGNOR has not executed and will not execute any agreement in conflict with this Assignment;

AND, ASSIGNOR HEREBY further covenants and agrees that ASSIGNOR will, without further consideration, communicate with ASSIGNEE, its successors and assigns, any facts known to ASSIGNOR respecting the invention and testify in any legal proceeding, sign all lawful papers that may be necessary or desirable to perfect the title to the invention in said ASSIGNEE, its successors and assigns, execute all rightful oaths, and generally do everything possible to aid ASSIGNEE, its successors and assigns, to prosecute any patent application described above and obtain and enforce proper patent protection for the invention in the United States and in any other country, it being understood that any expense incident to the execution of such papers shall be borne by ASSIGNEE, its successors and assigns.

IN TESTIMONY WHEREOF, ASSIGNOR has executed his Assignment the day and year below written.



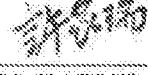
[ZHANG, YI]

Date: 2022-04-18



[QIAN, CHAO]

Date: 2022-04-18



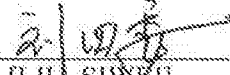
[XU, JIAYU]

Date: 2022-04-18



[BEI, RUNXIN]

Date: 2022-04-18



[LIU, SIWEI]

Date: 2022-04-18



[CHI, ZHENGUO]

Date: 2022-04-18